OptiPlex 7000 Small Form Factor

Technical Guidebook



Notes, cautions, and warnings

(i) NOTE: A NOTE indicates important information that helps you make better use of your product.

CAUTION: A CAUTION indicates either potential damage to hardware or loss of data and tells you how to avoid the problem.

MARNING: A WARNING indicates a potential for property damage, personal injury, or death.

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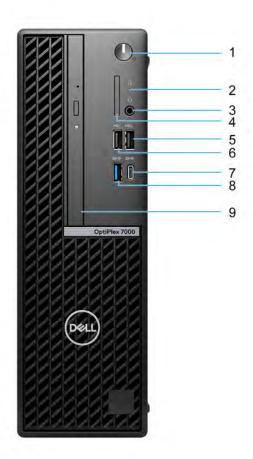
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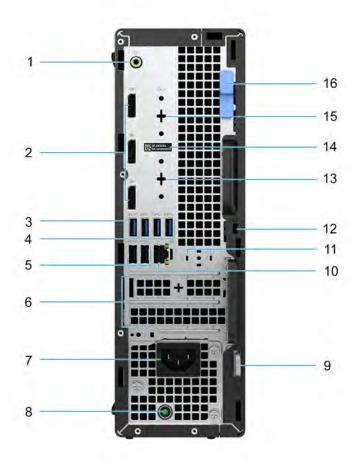
Views of OptiPlex 7000 Small Form Factor

Display



- 1. Power button
- 2. Hard-drive activity light
- 3. Universal audio port
- **4.** SD-card reader (optional)
- 5. USB 2.0 port with PowerShare
- **6.** USB 2.0 port
- 7. USB 3.2 Gen 2x2 Type-C port
- 8. USB 3.2 Gen 2 port
- 9. Slim optical drive (optional)

Back



- 1. Re-tasking line-out/line-in audio port
- 2. Three DisplayPort 1.4 ports
- 3. USB 3.2 Gen 2 port
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- 5. Two USB 2.0 ports with Smart Power On
- **6.** Two expansion card slots
- 7. Power port
- 8. Power-supply diagnostics light
- 9. Padlock ring
- 10. RJ45 Ethernet port
- 11. External antenna slot
- 12. Kensington security-cable slot
- 13. HDMI 2.0b/DisplayPort 1.4/VGA/USB 3.2 Gen 2 type-C port with DisplayPort Alt Mode (optional)
- 14. Service Tag label
- 15. Serial/PS2 port (optional)
- 16. Release latch

Specifications of OptiPlex 7000 Small Form Factor

Dimensions and weight

The following table lists the height, width, depth, and weight of your OptiPlex 7000 Small Form Factor.

Table 1. Dimensions and weight

Description	Values
Height:	
Front height	290.00 mm (11.42 in.)
Rear height	290.00 mm (11.42 in.)
Width	92.60 mm (3.65 in.)
Depth	292.80 mm (11.53 in.)
Weight (maximum)	Minimum: 3.85 kg (8.50 lb)Maximum: 5.30 kg (11.69 lb)
	(i) NOTE: The weight of your computer depends on the configuration ordered and manufacturing variability.

Processor

The following table lists the details of the processors that are supported by your OptiPlex 7000 Small Form Factor .

Table 2. Processor

Description	Option one	Option two	Option three	Option four	Option five	Option six	Option seven
Processor type	12 th Generation Intel Core i3-12100	12 th Generation Intel Core i3-12300	12 th Generation Intel Core i5-12400	12 th Generation Intel Core i5-12500 vPro	12 th Generation Intel Core i5-12600 vPro	12 th Generation Intel Core i7-12700 vPro	12 th Generation Intel Core i9-12900 vPro
Processor wattage	60 W	60 W	65 W	65 W	65 W	65 W	65 W
Processor core count	4	4	6	6	6	12	16
Processor thread count	8	8	12	12	12	20	24
Processor speed	3.30 GHz to 4.30 GHz	3.50 GHz to 4.40 GHz	2.50 GHz to 4.40 GHz	3.00 GHz to 4.60 GHz	3.30 GHz to 4.80 GHz	2.10 GHz to 4.90 GHz	2.40 GHz to 5.10 GHz
Processor cache	12 MB	12 MB	18 MB	18 MB	18 MB	25 MB	30 MB

Table 2. Processor (continued)

Description	Option one	Option two	Option three	Option four	Option five	Option six	Option seven
Integrated graphics	Intel UHD Graphics 730	Intel UHD Graphics 730	Intel UHD Graphics 730	Intel UHD Graphics 770		Intel UHD Graphics 770	Intel UHD Graphics 770

Chipset

The following table lists the details of the chipset supported by your OptiPlex 7000 Small Form Factor.

Table 3. Chipset

Description	Values
Chipset	Intel Q670
Processor	12 th Generation Intel Core i3/i5/i7/i9
DRAM bus width	64-bit, dual-channel
Flash EPROM	32 MB + 16 MB
PCle bus	Up to Gen 4.0

Operating system

Your OptiPlex 7000 Small Form Factor supports the following operating systems:

- Windows 11 Home, 64-bit
- Windows 11 Pro, 64-bit
- Windows 11 Downgrade (Windows 10 image)
- Windows 11 Pro National Education, 64-bit
- Windows 11 CMIT Government Edition, 64-bit (China only)
- Kylin Linux Desktop version 10.1 (China only)
- Ubuntu Linux 20.04 LTS, 64-bit

Memory

The following table lists the memory specifications of your OptiPlex 7000 Small Form Factor.

Table 4. Memory specifications

Description	Values
Memory slots	Four UDIMM slots
Memory type	Dual-channel, DDR4
Memory speed	3200 MHz
Maximum memory configuration	128 GB
Minimum memory configuration	4 GB

Table 4. Memory specifications (continued)

Description	Values
Memory size per slot	4 GB, 8 GB, 16 GB, and 32 GB
Memory configurations supported	4 GB, 1 x 4 GB, DDR4, 3200 MHz, single-channel
	8 GB, 1 x 8 GB, DDR4, 3200 MHz, single-channel
	8 GB, 2 x 4 GB, DDR4, 3200 MHz, dual-channel
	• 16 GB, 1 x 16 GB, DDR4, 3200 MHz, single-channel
	• 16 GB, 2 x 8 GB, DDR4, 3200 MHz, dual-channel
	• 32 GB, 1 x 32 GB, DDR4, 3200 MHz, single-channel
	• 32 GB, 2 x 16 GB, DDR4, 3200 MHz, dual-channel
	• 32 GB, 4 x 8 GB, DDR4, 3200 MHz, dual-channel
	• 64 GB, 2 x 32 GB, DDR4, 3200 MHz, dual-channel
	• 64 GB, 4 x 16 GB, DDR4, 3200 MHz, dual-channel
	• 128 GB, 4 x 32 GB, DDR4, 3200 MHz, dual-channel

Memory matrix

The following table lists the memory configurations supported on your OptiPlex 7000 Small Form Factor.

Table 5. Memory matrix

Configurati			Slot	
on	UDIMM1	UDIMM2	UDIMM3	UDIMM4
4 GB DDR4	4G			
8 GB DDR4	4G	4G		
8 GB DDR4	8G			
16 GB DDR4	8G	8G		
16 GB DDR4	16G			
32 GB DDR4	8G	8G	8G	8G
32 GB DDR4	16G	16G		
32 GB DDR4	32G			
64 GB DDR4	16G	16G	16G	16G
64 GB DDR4	32G	32G		
128 GB DDR4	32G	32G	32G	32G

External ports

The following table lists the external ports of your OptiPlex 7000 Small Form Factor.

Table 6. External ports

Description	Values	
Network port	One RJ45 Ethernet port (rear)	
USB ports	 One USB 2.0 port with PowerShare (front) One USB 2.0 port (front) One USB 3.2 Gen 2 port (front) One USB 3.2 Gen 2x2 Type-C port (front) Three USB 3.2 Gen 1 ports (rear) One USB 3.2 Gen 2 port (rear) Two USB 2.0 ports with Smart Power On (rear) 	
Audio port	One Universal audio port (front)One Re-tasking line-out/line-in audio port (rear)	
Video port	Three DisplayPort 1.4 ports One HDMI 2.0b/DisplayPort 1.4/VGA/USB 3.2 Gen 2 type-C port with DisplayPort Alt Mode (optional) NOTE: Download and install the latest Intel Graphics driver from www.dell.com/support to enable multiple displays.	
Media-card reader	One SD-card 4.0 slot (front, optional)	
Power-adapter port	Not supported	
Security-cable slot	One Kensington lock slot One Padlock ring	

Internal slots

The following table lists the internal slots of your OptiPlex 7000 Small Form Factor.

Table 7. Internal slots

Description	Values
PCIe Expansion	 One Half-height Gen4 PCle x16 slot One Half-height Gen4 PCle x4 slot
SATA	Three SATA 3.0 slots for 3.5-inch/2.5-inch hard drive and slim optical drive
M.2	 One M.2 2230 slot for WiFi and Bluetooth card 1st M.2 2230/2280 slot for solid-state drive 2nd M.2 2230 slot for solid-state drive 3rd M.2 2280 slot for solid-state drive NOTE: To learn more about the features of different types of M.2 cards, see the knowledge base article 000144170 at www.dell.com/support.

Ethernet

The following table lists the wired Ethernet Local Area Network (LAN) specifications of your OptiPlex 7000 Small Form Factor.

Table 8. Ethernet specifications

Description	Values	
Model number	Intel I225	
Transfer rate	10/100/1000/2500 Mbps	

Wireless module

The following table lists the Wireless Local Area Network (WLAN) module specifications of your OptiPlex 7000 Small Form Factor.

Table 9. Wireless module specifications

Description	Option one	Option two	Option three
Model number	Intel AX211	Intel Dual Band Wireless-AC 9462	MediaTek MT7921
Transfer rate	Up to 2400 Mbps	Up to 433 Mbps	Up to 1200 Mbps
Frequency bands supported	2.4 GHz/5 GHz /6 GHz (i) NOTE: The 6 GHz frequency is supported on computers installed with Windows 11 operating system only.	2.4 GHz/5 GHz	2.4 GHz/5 GHz
Wireless standards	 WiFi 802.11a/b/g Wi-Fi 4 (WiFi 802.11n) Wi-Fi 5 (WiFi 802.11ac) Wi-Fi 6E (WiFi 802.11ax) 	 WiFi 802.11a/b/g Wi-Fi 4 (WiFi 802.11n) Wi-Fi 5 (WiFi 802.11ac) 	 WiFi 802.11a/b/g Wi-Fi 4 (WiFi 802.11n) Wi-Fi 5 (WiFi 802.11ac) Wi-Fi 6 (WiFi 802.11ax)
Encryption	 64-bit and 128-bit WEP 128-bit AES-CCMP TKIP 256-bit AES-GCMP 	64-bit and 128-bit WEP128-bit AES-CCMPTKIP	64-bit and 128-bit WEP128-bit AES-CCMPTKIP
Bluetooth	5.2	5.1	5.2

Audio

The following table lists the audio specifications of your OptiPlex 7000 Small Form Factor.

Table 10. Audio specifications

Description	Values
Audio controller	Realtek Audio Controller, ALC3246-CG
Stereo conversion	24-bit DAC (Digital-to-Analog) and ADC (Analog-to-Digital)
Internal audio interface	Intel HDA (high-definition audio)

Table 10. Audio specifications (continued)

Description		Values	
External audio interface		One Universal audio port (front)One Re-tasking line-out/line-in audio port (rear)	
Number of speakers		One internal speaker (optional)	
Internal-speaker amplif	fier	Supported (audio codec integrated)	
External volume contro	bls	Keyboard shortcut controls	
Speaker output:			
	Average speaker output	2 W	
Peak speaker output		2.5W	
Subwoofer output		Not supported	
Microphone		Dual-array microphones	

Storage

This section lists the storage options on your OptiPlex 7000 Small Form Factor.

Table 11. Storage matrix

Storage		1 st 2.5- inch hard drive	2 nd 2.5- inch hard drive	3.5-inch hard drive	1 st M.2 socket (2230/2 280)	2 nd M.2 socket (2230)	3 rd M.2 socket (2280)	1 st Bootabl e Device
2.5-inch hard drive		Yes	No	No	No	No	No	2.5-inch hard drive
Dual 2.5-inch hard driv	ve	Yes	Yes	No	No	No	No	2.5-inch hard drive
3.5-inch hard drive		No	No	Yes	No	No	No	3.5-inch hard drive
M.2 solid-state drive		No	No	No	Yes	No	No	1 st M.2 solid- state drive
Dual M.2 solid-state dr	rive	No	No	No	Yes	Yes	No	1 st M.2 solid- state drive
M.2 solid-state drive	3.5-inch hard drive	No	No	Yes	Yes	No	No	1 st M.2 solid- state drive
M.2 solid-state drive	2.5-inch hard drive/ solid-state drive	Yes	No	No	Yes	No	No	1 st M.2 solid- state drive

Table 11. Storage matrix (continued)

Storage		1 st 2.5- inch hard drive	2 nd 2.5- inch hard drive	3.5-inch hard drive	1 st M.2 socket (2230/2 280)	2 nd M.2 socket (2230)	3 rd M.2 socket (2280)	1 st Bootabl e Device
M.2 solid-state drive	Dual 2.5-inch hard drive	Yes	Yes	No	Yes	No	No	1 st M.2 solid- state drive
Dual M.2 solid-state drive	2.5-inch hard drive	Yes	No	No	Yes	Yes	No	1 st M.2 solid- state drive
Dual M.2 solid-state drive	3.5-inch hard drive	No	No	Yes	Yes	Yes	No	1 st M.2 solid- state drive
Three M.2 solid-state	drive	No	No	No	Yes	Yes	Yes	1 st M.2 solid- state drive
Three M.2 solid-state drive	3.5-inch hard drive	No	No	Yes	Yes	Yes	Yes	1 st M.2 solid- state drive
Three M.2 solid-state drive	2.5-inch hard drive	Yes	No	No	Yes	Yes	Yes	1 st M.2 solid- state drive
Three M.2 solid-state drive	Dual 2.5-inch hard drive	Yes	Yes	No	Yes	Yes	Yes	1 st M.2 solid- state drive

Table 12. Storage specifications

Storage type	Interface type	Capacity
2.5-inch, 5400 RPM, hard-disk drive	SATA 3.0	Up to 2 TB
2.5-inch, 7200 RPM, hard-disk drive	SATA 3.0	Up to 1 TB
2.5-inch, 7200 RPM, Opal Self- Encrypting hard-disk drive	SATA 3.0	500 GB
3.5-inch, 5400 RPM, hard-disk drive	SATA 3.0	4 TB
3.5-inch, 7200 RPM, hard-disk drive	SATA 3.0	Up to 2 TB
M.2 2230, SSD, Class 35	PCIe NVMe Gen3 x4	Up to 1 TB
M.2 2230, SSD, Class 35, Opal Self- Encrypting Opal 2.0, FIPS	PCle NVMe Gen3 x4	256 GB
M.2 2280, SSD, Class 40	PCle NVMe Gen4 x4	Up to 2 TB
M.2 2280, SSDClass 40, Self-Encrypting, Opal 2.0, FIPS	PCIe NVMe Gen3 x4	Up to 1 TB

RAID (Redundant Array of Independent Disks)

For optimal performance when configuring drives as a RAID volume, Dell recommends drive models that are identical.

i NOTE: RAID is not supported on Intel Optane configurations.

RAID 0 (Striped, Performance) volumes benefit from higher performance when drives are matched because the data is split across multiple drives: any IO operations with block sizes larger than the stripe size will split the IO and become constrained by the slowest of the drives. For RAID 0 IO operations where block sizes are smaller than the stripe size, whichever drive the IO operation targets will determine the performance, which increases variability and results in inconsistent latencies. This variability is particularly pronounced for write operations and it can be problematic for applications that are latency sensitive. One such example of this is any application that performs thousands of random writes per second in very small block sizes.

RAID 1 (Mirrored, Data Protection) volumes benefit from higher performance when drives are matched because the data is mirrored across multiple drives: all IO operations must be performed identically to both drives, thus variations in drive performance when the models are different, results in the IO operations completing only as fast as the slowest drive. While this does not suffer the variable latency issue in small random IO operations as with RAID 0 across heterogeneous drives, the impact is nonetheless large because the higher performing drive becomes limited in all IO types. One of the worst examples of constrained performance here is when using unbuffered IO. To ensure writes are fully committed to non-volatile regions of the RAID volume, unbuffered IO bypasses cache (for example by using the Force Unit Access bit in the NVMe protocol) and the IO operation will not complete until all the drives in the RAID volume have completed the request to commit the data. This kind of IO operation completely negates any advantage of a higher performing drive in the volume.

Care must be taken to match not only the drive vendor, capacity, and class, but also the specific model. Drives from the same vendor, with the same capacity, and even within the same class, can have very different performance characteristics for certain types of IO operations. Thus, matching by model ensures that the RAID volumes is comprised of an homogeneous array of drives that will deliver all the benefits of a RAID volume without incurring the additional penalties when one or more drives in the volume are lower performing.

OptiPlex 7000 Small Form Factor supports RAID with more than one hard drive configuration.

Media-card reader

The following table lists the media cards supported by your OptiPlex 7000 Small Form Factor.

Table 13. Media-card reader specifications

Description	Values
Media-card type	One SD-card 4.0 slot
Media-cards supported	 Secure Digital (mSD) Secure Digital High Capacity(mSDHC) Secure Digital Extended Capacity(mSDXC)
NOTE: The maximum capacity supported by the media-capinstalled in your computer.	ard reader varies depending on the standard of the media card

Power ratings

The following table lists the power rating specifications of OptiPlex 7000 Small Form Factor.

Table 14. Power ratings

Description	Option one	Option two	Option three
Type	240 W (85% Efficient, 80 PLUS Bronze)	260 W (85% Efficient, 80 PLUS Bronze)	300 W (92% Efficient, 80 Plus Platinum)
Input voltage	90 VAC-264 VAC	90 VAC-264 VAC	90 VAC-264 VAC

Table 14. Power ratings (continued)

Description	Option one	Option two	Option three	
Input frequency	47 Hz-63 Hz	47 Hz - 63 Hz	47 Hz-63 Hz	
Input current (maximum)	4.0 A	4.2 A	4.2 A	
Output current (continuous)	Operating: 12 VA/18 A 12 VB/16 A Standby mode: 12 VA/1.5 A 12 VB/3.3 A	Operating: 12 VA/18 A 12 VB/16 A Standby mode: 12 VA/1.5 A 12 VB/3.3 A	Operating: 12 VA/18 A 12 VB/18 A Standby mode: 12 VA/1.5 A 12 VB/3.3 A	
Rated output voltage	• +12 VA • +12 VB	• +12 VA • +12 VB	• +12 VA • +12 VB	
Temperature range:				
Operating	5°C to 45°C (41°F to 113°F)	5°C to 45°C (41°F to 113°F)	5°C to 45°C (41°F to 113°F)	
Storage	-40°C to 70°C (-40°F to 158°F)	-40°C to 70°C (-40°F to 158°F)	-40°C to 70°C (-40°F to 158°F)	

Power supply connector

The following table lists the Power supply connector specifications of your OptiPlex 7000 Small Form Factor.

Table 15. Power supply connector

240 W (80 PLUS Bronze)	Two 4 pin connectors for processorOne 8 pin connector for system board
260 W (80 PLUS Bronze)	Two 4 pin connectors for processorOne 8 pin connector for system board
300 W (80 PLUS Platinum)	Two 4 pin connectors for processorOne 8 pin connector for system board

GPU—Integrated

The following table lists the specifications of the integrated Graphics Processing Unit (GPU) supported by your OptiPlex 7000 Small Form Factor.

Table 16. GPU—Integrated

Controller	Memory size	Processor
Intel UHD Graphics 730	Shared-system memory	12 th Generation Intel Core i3-12100, i3-12300, and i5-12400 processors
Intel UHD Graphics 770	Shared-system memory	12 th Generation Intel Core i5-12500, i5-12600, i7-12700, and i9-12900 processors

Multiple display support matrix

The following table lists the multiple display support matrix for integrated graphics options on your OptiPlex 7000 Small Form Factor.

Table 17. Multiple display support matrix

Description	Option 1	Option 3
Integrated Graphics Card	Intel UHD Graphics 730	Intel UHD Graphics 770
Optional Module	Option card with VGA (1920x1200 @ 60 Hz) Option card with DP1.4 (5120x3200 @60 Hz) Option card with HDMI 2.0 (4096x2160 @ 60 Hz) Option card with Type-C (5120x3200 @ 60 Hz)	Option card with VGA (1920x1200 @ 60 Hz) Option card with DP1.4 (5120x3200 @60 Hz) Option card with HDMI 2.0 (4096x2160 @ 60 Hz) Option card with Type-C (5120x3200 @ 60 Hz)
Supported 4K Displays	DP1.4 HBR2, 4096 x 2304 @ 60 Hz	DP1.4 HBR2, 4096 x 2304 @ 60 Hz
Supported 5K Displays	5K tiled resolution (5120x2880) support on DP panels. NOTE: Needs two DP cables driven through two separate DDIs from the source, and using DP-SST (Single Stream Transport) mechanism.	5K tiled resolution (5120x2880) support on DP panels. NOTE: Needs two DP cables driven through two separate DDIs from the source, and using DP-SST (Single Stream Transport) mechanism.

GPU—Discrete

The following table lists the specifications of the discrete Graphics Processing Unit (GPU) supported by your OptiPlex 7000 Small Form Factor.

Table 18. GPU—Discrete

Controller	Memory size	Memory type
AMD Radeon RX640	4 GB	GDDR5
AMD Radeon 550	2 GB	GDDR5
AMD Radeon 540	1 GB	GDDR5

Multiple display support matrix

The following table provides the multiple display support matrix for discrete graphics options on your OptiPlex 7000 Small Form Factor.

Table 19. Multiple display support matrix

Graphics Card	Radeon RX 640	Radeon 550	Radeon 540
Memory	4 GB	2 GB	1 GB
Ports	2 x Mini-DP 1.4 ports1 x DP 1.4 port	• 2 x DP 1.4 port	• 2 x DP 1.4 port
Supported external displays with Direct Connect	3	2	2
Supported external displays with DP Multi-Stream	4	4	4
Supported 4K Displays	DP1.4 HBR2, 4096 x 2304 @ 60 Hz	DP1.4 HBR2, 4096 x 2304 @ 60 Hz	DP1.4 HBR2, 4096 x 2304 @ 60 Hz

Table 19. Multiple display support matrix (continued)

Graphics Card	Radeon RX 640	Radeon 550	Radeon 540
Supported 5K Displays	5K tiled resolution (5120x2880) support on DP panels. NOTE: Needs two DP cables driven through two separate DDIs from the source, and using DP-SST (Single Stream Transport) mechanism.	5K tiled resolution (5120x2880) support on DP panels. NOTE: Needs two DP cables driven through two separate DDIs from the source, and using DP-SST (Single Stream Transport) mechanism.	5K tiled resolution (5120x2880) support on DP panels. NOTE: Needs two DP cables driven through two separate DDIs from the source, and using DP-SST (Single Stream Transport) mechanism.
Resolution	5120 x 2880 @60 Hz	5120 x 2880 @60 Hz	5120 x 2880 @60 Hz
Total Power	50 W	50 W	50 W

Hardware security

The following table lists the hardware security of your OptiPlex 7000 Small Form Factor.

Table 20. Hardware security

Hardware security Kensington security-cable slot Padlock ring Chasis lock slot support Chassis intrusion switch Lockable cable covers Supply chain tamper alerts
Padlock ring Chasis lock slot support Chassis intrusion switch Lockable cable covers Supply chain tamper alerts
Chasis lock slot support Chassis intrusion switch Lockable cable covers Supply chain tamper alerts
Chassis intrusion switch Lockable cable covers Supply chain tamper alerts
Lockable cable covers Supply chain tamper alerts
Supply chain tamper alerts
CofalD isoluding Trusted Dietform Module (TDM) 0.0
SafeID including Trusted Platform Module (TPM) 2.0
Smart card keyboard (FIPS)
Microsoft 10 Device Guard and Credential Guard (Enterprise SKU)
Microsoft Windows Bitlocker
Local hard drive data wipe through BIOS (Secure Erase)
Self-encrypting storage drives (Opal, FIPS)
Trusted Platform Module TPM 2.0
China TPM
Intel Secure Boot
Intel Authenticate
SafeBIOS: includes Dell Off-host BIOS Verification, BIOS Resilience, BIOS Recovery, and additional BIOS Controls

Environmental

The following table lists the environmental specifications of your OptiPlex 7000 Small Form Factor.

Table 21. Environmental

Feature	Values
Recyclable packaging	Yes
BFR/PVC—free chassis	No
Vertical orientation packaging support	Yes
Multi-Pack packaging	Yes
Energy-Efficient Power Supply	Standard
ENV0424 compliant	Yes

NOTE: Wood-based fiber packaging contains a minimum of 35% recycled content by total weight of wood-based fiber. Packaging that contains without wood-based fiber can be claimed as Not Applicable. The anticipated required criteria for EPEAT 2018.

Regulatory compliance

The following table lists the regulatory compliance of your OptiPlex 7000 Small Form Factor.

Table 22. Regulatory compliance

Regulatory compliance	
EPEAT registered configurations available	
ENERGY STAR compliant configurations available	
TCO 8.0 certified configurations available	
US CEC MEPS compliant configurations available	
Australia and New Zealand MEPS compliant configurations available	
CEL	
WEEE	
Japan Energy Law	
South Korea E-standby	
EU RoHS	
China RoHS	

Operating and storage environment

This table lists the operating and storage specifications of your OptiPlex 7000 Small Form Factor.

Airborne contaminant level: G1 as defined by ISA-S71.04-1985

Table 23. Computer environment

Description	Operating	Storage
Temperature range	10°C – 35°C (50°F – 95°F)	-40°C-65°C (-40°F-149°F)

Table 23. Computer environment (continued)

Description	Operating	Storage
Relative humidity (maximum)	20% to 80% (non-condensing, Max dew point temperature = 26°C)	5% to 95% (non-condensing, Max dew point temperature = 33°C)
Vibration (maximum)*	0.26 GRMS random at 5 Hz to 350 Hz	1.37 GRMS random at 5 Hz to 350 Hz
Shock (maximum)	Bottom half-sine pulse with a change in velocity of 40.20 cm/sec (20 in./sec)	105G half-sine pulse with a change in velocity of 105.20 cm/sec (52.5 in./sec)
Altitude range	-15.2 m to 3048 m (-49 ft to 10,000 ft)	-15.2 m to 10,668 m (-49 ft to 35,000 ft)

CAUTION: Operating and storage temperature ranges may differ among components, so operating or storing the device outside these ranges may impact the performance of specific components.

 $[\]ensuremath{^{*}}$ Measured using a random vibration spectrum that simulates user environment.

[†] Measured using a 2 ms half-sine pulse.

Engineering specifications

Physical system dimensions

The following table provides the physical dimensions of your OptiPlex 7000 Small Form Factor.

NOTE: System weight and shipping weight are based on a typical configuration and may vary based on your system configuration. A typical configuration includes integrated graphics, one hard drive, and one optical drive.

Table 24. Physical system dimensions

Feature	Values	
Chassis volume	7.86 Liters	
Chassis Weight	Maximum: 5.30 kg (11.69 lb)	
	Minimum: 3.85 kg (8.50 lb)	
Chassis dimensions		
Height	290 mm (11.42 in.)	
Width	92.60 mm (3.65 in.)	
Depth	292.80 mm (11.53 in.)	
Shipping Weight (includes packaging materials)	6.72 kg (14.80 lb)	
Packaging dimensions		
Height	487 mm (19.17 in)	
Width	264 mm (10.39 in)	
Depth	394 mm (15.51 in)	

Add-in card dimensions

Slot limitations

The following table lists the system board connector maximum add-in card allowable dimensions of your OptiPlex 7000 Small Form Factor.

Table 25. Slot limitations of add-in cards

Feature	Values
PCIe x16 connector	1
Voltage	3.3 V/12 V
Height	2.71 in. (68.90 mm)
Length	6.60 in. (167.64 mm)
Maximum wattage	50 W

Table 25. Slot limitations of add-in cards (continued)

Feature	Values
PCIe x4 connector	1
Voltage	3.3 V/12 V
Height	2.71 in. (68.90 mm)
Length	6.60 in. (167.64 mm)
Maximum wattage	25 W

Table 26. M.2 2230 slot for Wi-Fi card

Voltage	3.3 V
Width	0.86 in. (22.00 mm)
Length	1.18 in. (30.00 mm)
Thickness	0.14 in. (3.65 mm)
Maximum wattage	6.6 W

Table 27. M.2 2230 slot for solid-state drive

Voltage	3.3 V
Width	0.86 in. (22.00 mm)
Length	1.18 in. (30.00 mm)
Thickness	0.14 in. (3.65 mm)
Maximum wattage	6.6 W

Table 28. M.2 2280 slot for solid-state drive

Voltage	3.3 V
Width	0.86 in. (22.00 mm)
Length	3.14 in. (80.00 mm)
Thickness	0.15 in. (3.80 mm)
Maximum Wattage	8.25 W

Dust filter

The following table lists the dust filter specifications of your OptiPlex 7000 Small Form Factor.

Table 29. Dust filter

Feature	Values
Туре	0.008 in. (0.0196 cm)
Mesh count	100.00 in. (39.37 cm)
Weave	Plain
Silk diameter	0.002 in. (0.005 cm)
Open area	61 %

Table 29. Dust filter (continued)

Feature	Values
Thickness	0.004 in. (0.01 cm)
Remark	PET

PCle add-in cards

SD-card 4.0 reader

The following table lists the SD-card 4.0 reader specifications.

Table 30. SD-card 4.0 reader specifications

Feature	Values	
Interface	Input: PCI Express,	
	Output: SD 4.0 card	
Data rates	SD 4.0 UHS-II Up to 312 MB/sec	
Controller details		
Controller	GL9755	
Controller bus architecture	PCIe 2.1	
Driver support	Yes	
Environment		
Operating temperature	0°C to 70°C (32°F to 158°F)	

Serial port PCIe add-in card

Table 31. Serial port PCle add-in card

Feature	Values
Interface	● RS-232 ● IEEE1284
Data rates	50 bps ~115.2 Kbps (serial)maximum 1.8 Mbps (parallel)
Controller details	
Controller	SUNIX SUN2212 (16C950 UART compatible)
Controller bus architecture	PCI Express 2.0Single-Lane (x1)
Driver support	Windows 10 (64-bit)
Half-height serial add-in dongle	Optional
Environment	
Operating temperature	0°C to 60°C (32°F-140°F)
Operating humidity	5% to 95% RH
Storage temperature	-20°C to 85°C (-4°F to 185°F)

Parallel port PCle add-in card

Table 32. Parallel port PCle add-in card

Feature	Values
Interface	• RS-232 • IEEE1284
Data rates	50 bps ~115.2 Kbps (serial)maximum 1.8 Mbps (parallel)
Controller details	
Controller	SUNIX SUN2212 (16C950 UART compatible)
Controller bus architecture	PCI Express 2.0Single-Lane (x1)
Driver support	Windows 10 (64-bit)
Half-height parallel add-in dongle	Optional
Environment	
Operating temperature	0°C to 60°C (32°F–140°F)
Operating humidity	5% to 95% RH
Storage temperature	-20°C to 85°C (-4°F to 185°F)

PS/2 Serial add-in bracket

The following table lists the PS/2 Serial add-in bracket specifications.

Table 33. PS/2 Serial add-in bracketspecifications

Feature	Values	
Interface	UART	
Data rates	250 kbps / 235 kbps	
Controller details		
Controller	Microchip DEC1515	
Controller bus architecture	PCle	
Driver support	N/A	
Half-height serial add-in dongle	N/A	
Environment		
Operating temperature	0°C to 70°C (32°F to 158°F) / -40°C to 85°C (-40°F to 185°F	
Operating humidity	60% RH	
Storage temperature	-65°C to 150°C (-85°F to 302°F)	

Ethernet

Intel Ethernet Connection i225

The following table lists the i225 specifications.

Table 34. Intel Ethernet Connection i225 specifications

Feature	Values
External connector type	RJ45
Data rate	10/100/1000/2500 Mbps
LED indicators	Link - SolidActivity - Blinking
LED color	 Green - 2.5 Gbps Yellow - 1 Gbps LED off - 100 Mbps or 10 Mbps
Adapter Features	
Bus Type/Bus Width	PCI Express 3.1 x 1
Interrupt levels	INTA, MSI, MSI-X
Hardware certifications	FCC B, UL, CE, VCCI, BSMI, CTICK, KCC, EEE
Controller	Intel Ethernet Controller I225
Bracket	Full-height bracket installed. Low-profile bracket included in the package
Power Consumption	
Link Speed / Traffic	Typical power
10 Mbps	.5 W
100 Mbps	.6 W
1 Gbe	1 W
2.5 Gbe	1.9 W
Environmental	
Operating temperature range	0°C-55°C (32°F-131°F)
Storage temperature range	-40°C-70°C (-40°F-158°F)
Storage humidity	Maximum 90% non-condensing relative humidity at 35°C
Physical Dimensions	
Dimensions	68.7 mm x 65.3 mm

Wireless module

MediaTek MT7921, 2x2, Wi-Fi 6 (WiFi 802.11ax), Bluetooth 5.2

The following table lists the MediaTek MT7921 specifications.

Table 35. MediaTek MT7921 specifications

Host interface	Wi-Fi - PCle Bluetooth - USB
Network standard	IEEE 802.11a/b/g/n/ac/ax, MU-MIMO
Wi-Fi Alliance certifications	 802.11 a/b/g/n/ac R2/ax R2 WMM WMM-PS WPA3 WPS2 PMF WFD Miracast Passpoint R2 Voice Personal
Operating frequency bands	2.4 Ghz5 Ghz
Data rate	2.4 GHz 40M: Up to 576 Mbps5 GHz 160M: Up to 1.2 Gbps
Power consumption	Optimized power modes (sleep states) reduce power consumption during periods of inactivity
Authentication	WPA and WPA2 Personal and EnterpriseWPA3 Personal and Enterprise
Authentication protocols	 802.1X EAP-TLS EAP-TTLS/MSCHAPv2 PEAPv0 -MSCHAPv2 (EAP-SIM, EAP-AKA, EAP-AKA)
Encryption	 64-bit and 128-bit WEP TKIP 128-bit AES-CCMP 256-bit AES-GCMP
Product safety	ULC-ULCB (IEC60950-1)
Government compliance	FIPS 140-2FISMA
Antenna diversity	Supported
Radio On/Off	Supported
Roaming	Support seamless roaming between access points
Wake on wireless	supported
Wireless display	Native Miracast support by Windows
Wireless PAN standard	Dual Mode Bluetooth 5.2

Table 35. MediaTek MT7921 specifications (continued)

	• BLE
Bluetooth data rates	Up to 3 Mbps
Bluetooth operating frequency bands	2.4 GHz
Bluetooth profiles supported	Support for Microsoft Inbox Bluetooth profiles in Windows
Bluetooth data encryption	128-bit encryption
Bluetooth output power	Power class 1
Operating temperature	0° to +50° C (Full performance at shield temperatures up to 80° C)
Storage temperature	-40°C to +70°C
Humidity	Up to 90% RH non-condensing (at temperatures of 25° C to 35° C)

Intel 9462, 1x1, 433 Mbps, 2.40 Ghz /5 Ghz, Wi-Fi 5 (WiFi 802.11ac), Bluetooth 5.1

The following table lists the Intel 9462 specifications.

Table 36. Intel 9462 specifications

Host interface	CNVi (Connectivity Integration)	
Network standard	IEEE 802.11a/b/g/n/ac	
Wi-Fi Alliance certifications	 Wi-Fi CERTIFIED a/b/g/n/ac with wave 2 features WMM WMM-PS WPA WPA2 WPS2 Protected Management Frames Wi-Fi Direct (For Windows only) 	
Operating frequency bands	2.4 Ghz5 Ghz	
Data rate	2.4 GHz 40M: Up to 150 Mbps5 GHz 80M: Up to 433 Mbps	
Power consumption	Optimized power modes (sleep states) reduce power consumption during periods of inactivity	
Authentication	 WPA and WPA2 802.1X (EAP-TLS, TTLS, PEAP, EAP-SIM, EAP-AKA, EAP-AKA) 	
Authentication protocols	 PAP CHAP TLS GTC MS-CHAP MS-CHAP v2 	
Encryption	64-bit and 128-bit WEP TKIP	

Table 36. Intel 9462 specifications (continued)

	128-bit AES-CCMP	
Product safety	ULC-ULCB (IEC60950-1)	
Government compliance	FIPS FISMA	
Client utility	Intel PRO/Set wireless software v20 and later	
Antenna diversity	Supported	
Radio On/Off	Supported	
Roaming	Support seamless roaming between access points	
Wake on wireless	Supported	
Wireless display	Native Miracast support by Windows	
Wireless PAN standard	Dual Mode Bluetooth 5.1BLE	
Bluetooth data rates	Up to 3Mbps	
Bluetooth operating frequency bands	2.4 GHz	
Bluetooth profiles supported	Support for Microsoft Inbox Bluetooth profiles in Windows	
Bluetooth data encryption	128-bit encryption	
Bluetooth output power	Power class 1	
Operating temperature	0°C to + 50°C (Full performance at shield temperatures up to 80°C)	
Storage temperature	-40°C to +70°C	
Humidity	Up to 90% RH non-condensing (at temperatures of 25° C to 35° C)	

Intel AX211, 2x2 MIMO, 2400 Mbps, 2.4/5/6 GHz, Wi-Fi 6E (WiFi 802.11ax), Bluetooth 5.2

The following table lists the Intel AX211 specifications.

Table 37. Intel AX211 specifications

Host interface	CNVi3 (Connectivity Integration 3 rd generation)	
Network standard	IEEE 802.11a/b/g/n/ac/ax, 160MHz channel use, MU-MIMO new 6GHz band	
Wi-Fi Alliance certifications	Wi-Fi CERTIFIED 6, Wi-Fi CERTIFIED a/b/g/n/ac,WMM, WMM-Power Save, WPA2, WPA3, WPS, PMF,Wi-Fi Direct, Wi-Fi Agile Multiband i NOTE: Other names and brands may be claimed as the property of others.	
Operating frequency bands	2.4 GHz5 GHz6 GHz	
Data rate	• 2.4 GHz 40M: Up to 574 Mbps	

Table 37. Intel AX211 specifications (continued)

	5/6 GHz 80M: Up to 1.2 Gbps5/6 GHz 160M: Up to 2.4 Gbps
Power consumption	Optimized power modes (sleep states) reduce power consumption during periods of inactivity
Security methods	WPA2 Personal and EnterpriseWPA3
Authentication protocols	 802.1X EAP-TLS EAP-TTLS/MSCHAPv2 PEAPv0 -MSCHAPv2 (EAP-SIM, EAP-AKA, EAP-AKA)
Encryption	 64-bit and 128-bit WEP TKIP 128-bit AES-CCMP 256-bit AES-GCMP
Product safety	ULC-ULCB (IEC60950-1)
Management capabilities alerting	Support for Intel AMT
Government compliance	FIPS 140-2FISMA
Client utility	Intel PRO/Set wireless software v22 and later
Antenna diversity	Supported
Radio On/Off	Supported
Roaming	Support seamless roaming between access points
Wake on wireless	Supported
Wireless display	Native Miracast support by Windows
Wireless PAN standard	Dual Mode Bluetooth 5.2BLE
Bluetooth data rates	Up to 3 Mbps
Bluetooth operating frequency bands	2.4 GHz
Bluetooth profiles supported	Support for Microsoft Inbox Bluetooth profiles in Windows
Bluetooth data encryption	128-bit encryption
Bluetooth output power	Power class 1
Operating temperature	0°C to + 50°C (Full performance at shield temperatures up to 80°C)
Storage temperature	-40°C to +70°C
Humidity	Up to 90% RH non-condensing (at temperatures of 25° C to 35° C)

GPU—Integrated

Intel UHD Graphics 730

Table 38. Intel UHD Graphics 730 specifications

Intel UHD Graphics 730	<u> </u>	
Bus Type		Integrated
Memory type		Shared memory
Graphics Level		i3/i5: GT1 (UHD)
Overlay Planes		Yes
Operating Systems Graphics	/ Video API Support	DirectX 12, OpenGL (4.5 from Intel CML POR)
HDMI Support		HDMI2.0
HDCP Support		HDCP2.3
Supports maximum resolutio	n	 On board integrated DP1.4 (HBR2)(4096x2304 @ 60 Hz) Option card with DP1.4 (HBR3) (5120x3200 @ 60 Hz)
		 Option card with VGA (1920x1200 @ 60 Hz) Option card with HDMI 2.0 (4096x2160 @ 60 Hz) Option card with Type-C (5120x3200 @ 60 Hz)
Number of display supported	1	Up to four displays supported
Multiple Display Support	2 displays	 On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4(4096x2304 @ 60 Hz) On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with VGA (1920x1200 @ 60 Hz)
		 On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with DP1.4 (5120x3200 @ 60 Hz) On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with HDMI 2.0 (4096x2160 @ 60 Hz) On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with Type-C (5120x3200 @ 60 Hz)

Table 38. Intel UHD Graphics 730 specifications (continued)

Intel UHD Graphics 730)	
	3 displays	• On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4(4096x2304 @ 60 Hz) + Option card with VGA (1920x1200 @ 60 Hz)
		 On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4(4096x2304 @ 60 Hz) + Option card with DP1.4 (5120x3200 @ 60 Hz)
		 On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4(4096x2304 @ 60 Hz) + Option card with HDMI 2.0 (4096x2160 @ 60 Hz)
		• On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with Type-C (5120x3200 @ 60 Hz)
	4 displays	• On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4(4096x2304 @ 60 Hz) + On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with VGA (1920x1200 @ 60 Hz)
		• On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4(4096x2304 @ 60 Hz) + On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with DP1.4 (5120x3200 @ 60 Hz)
		• On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4(4096x2304 @ 60 Hz) + On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with HDMI2.0 (4096x2160 @ 60 Hz)
		• On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4(4096x2304 @ 60 Hz) + On board integrated DP1.4 (4096x2304 @ 60 Hz) +

Table 38. Intel UHD Graphics 730 specifications (continued)

Intel UHD Graphics 730	
	Option card with Type-C (5120x3200 @ 60 Hz)
External connectors	 Three DisplayPort 1.4 ports (rear) One Optional video port (VGA port/HDMI 2.0b port/Displayport 1.4a(HBR3)/USB Type-C with DisplayPort Alt mode)

Intel UHD Graphics 770

Table 39. Intel UHD Graphics 770 specifications

	noo // o opoomoationo	
Intel UHD Graphics 770		
Bus Type		Integrated
Memory Type		Shared memory
Graphics Level		i7/i9: GT1 (UHD)
Overlay Planes		Yes
Operating Systems Graphics/ Video API Support		DirectX 12, OpenGL (4.5 from Intel CML POR)
HDMI Support		HDMI2.0
HDCP Support		HDCP2.3
Supports maximum resolution		 On board integrated DP1.4 (HBR2)(4096x2304 @ 60 Hz) Option card with VGA
		(1920x1200 @ 60 Hz) • Option card with DP1.4 (HBR3) (5120x3200 @ 60 Hz) • Option card with HDMI 2.0 (4096x2160 @ 60 Hz) • Option card with Type-C (5120x3200 @ 60 Hz)
Number of display supported		Up to four displays supported
Multiple Display Support	2 displays	 On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4(4096x2304 @ 60 Hz)
		 On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with VGA (1920x1200 @ 60 Hz)
		• On board integrated DP1.4 (4096x2304 @ 60 Hz) +

Table 39. Intel UHD Graphics 770 specifications (continued)

Intel UHD Graphics 770			
		• O (2 O (ption card with DP1.4 5120x3200 @ 60 Hz) n board integrated DP1.4 4096x2304 @ 60 Hz) + ption card with HDMI 2.0 4096x2160 @ 60 Hz) n board integrated DP1.4 4096x2304 @ 60 Hz) + ption card with Type-C 5120x3200 @ 60 Hz)
	3 displays	(2 + D +	n board integrated DP1.4 1096x2304 @ 60 Hz) On board integrated P1.4(4096x2304 @ 60 Hz) Option card with VGA 920x1200 @ 60 Hz)
		(2 + D +	n board integrated DP1.4 1096x2304 @ 60 Hz) On board integrated P1.4(4096x2304 @ 60 Hz) Option card with DP1.4 5120x3200 @ 60 Hz)
		(2 + D +	n board integrated DP1.4 1096x2304 @ 60 Hz) On board integrated P1.4(4096x2304 @ 60 Hz) Option card with HDMI 2.0 1096x2160 @ 60 Hz)
		(4 0 (4 0	n board integrated DP1.4 4096x2304 @ 60 Hz) + n board integrated DP1.4 4096x2304 @ 60 Hz) + ption card with Type-C 5120x3200 @ 60 Hz)
	4 displays	(4 + D + (4 +	n board integrated DP1.4 1096x2304 @ 60 Hz) On board integrated P1.4(4096x2304 @ 60 Hz) On board integrated DP1.4 1096x2304 @ 60 Hz) Option card with VGA 920x1200 @ 60 Hz)
		+ D + (4	n board integrated DP1.4 4096x2304 @ 60 Hz) On board integrated P1.4(4096x2304 @ 60 Hz) On board integrated DP1.4 4096x2304 @ 60 Hz) + ption card with DP1.4 5120x3200 @ 60 Hz)
			n board integrated DP1.4 1096x2304 @ 60 Hz)

Table 39. Intel UHD Graphics 770 specifications (continued)

Intel UHD Graphics 770	
	+ On board integrated DP1.4(4096x2304 @ 60 Hz) + On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with HDMI2.0 (4096x2160 @ 60 Hz)
	• On board integrated DP1.4 (4096x2304 @ 60 Hz) + On board integrated DP1.4(4096x2304 @ 60 Hz) + On board integrated DP1.4 (4096x2304 @ 60 Hz) + Option card with Type-C (5120x3200 @ 60 Hz)
External connectors	Three DisplayPort 1.4 ports (rear)
	One Optional video port (VGA port/HDMI 2.0b port/ Displayport 1.4a(HBR3)/USB Type-C with DisplayPort Alt mode)

GPU—Discrete

AMD Radeon RX 640, 4 GB, GDDR5, low profile

The following table lists the AMD Radeon RX 640 specifications.

Table 40. AMD Radeon RX 640 specifications

Feature	Values
Dedicated graphics memory	4 GB, GDDR5
Memory bus	128-bit
Memory config	256 M x 32
Width	Single slot
Approximate wattage	50 W
Base clock	N/A
Boost clock	1500 MHz
Stream processors	512/640
G-Sync / Freesync ready	Yes
Supported APIs	DirectX 12OpenGL 4.5Vulkan API
Maximum resolution	5120 x 2880
HDMI support	N/A
HDCP support	N/A

Table 40. AMD Radeon RX 640 specifications (continued)

Feature	Values
I/O ports	Two Mini-DisplayPort 1.4 portsOne DisplayPort 1.4 port

AMD Radeon 550, 2 GB, GDDR5, low profile

The following table lists the AMD Radeon 550 specifications.

Table 41. AMD Radeon 550 specifications

Feature	Values		
Dedicated graphics memory	2 GB, GDDR5		
Memory bus	64-bit		
Memory config	256 M x 32		
Width	Single slot		
Approximate wattage	50 W		
Base clock	N/A		
Boost clock	1500 MHz		
Stream processors	512		
G-Sync / Freesync ready	Yes		
Supported APIs	DirectX 12OpenGL 4.5Vulkan API		
Maximum resolution	5120 x 2880		
HDMI support	N/A		
HDCP support	N/A		
I/O ports	Two DisplayPort 1.4 ports		

AMD Radeon 540, 1 GB, GDDR5, low profile

The following table lists the AMD Radeon 540 specifications.

Table 42. AMD Radeon 540 specifications

Feature	Values		
Dedicated graphics memory	1 GB, GDDR5		
Memory bus	32-bit		
Memory config	256 M x 32		
Width	Single slot		
Approximate wattage	50 W		
Base clock	N/A		
Boost clock	1500 MHz		
Stream processors	512		
G-Sync / Freesync ready	Yes		

Table 42. AMD Radeon 540 specifications (continued)

Feature	Values
Supported APIs	DirectX 12OpenGL 4.5Vulkan API
Maximum resolution	5120 x 2880
HDMI support	N/A
HDCP support	N/A
I/O ports	Two DisplayPort 1.4 ports

GPU and PSU matrix

The following table provides the GPU and PSU matrix of your OptiPlex 7000 Small Form Factor.

Table 43. GPU and PSU matrix

GFx card	Card length	Weight (kg)	Power connector	I/O connector	Single/Dual wide	PSU
AMD Radeon RX 640	6.60 in.	0.174	NA	1 x DP/2 x mDP	Single	75 W
AMD Radeon 550	6.60 in.	0.133	NA	2 x DP	Single	75 W
AMD Radeon 540	6.60 in.	0.132	NA	2 x DP	Single	75 W

Video port and resolution matrix

The following table lists the Video port and resolution matrix on your OptiPlex 7000 Small Form Factor.

Table 44. Video port and resolution matrix

Port type	DP++ 1.4 / HDCP 2.3 port (UMA and Discrete Graphics)	HDMI-OUT port— HDMI 1.4b (UMA Graphics)	HDMI-OUT port— HDMI 2.0 (Discrete Graphics)
Maximum resolution —single display	4096 x 2304 @ 60 Hz	4096 x 2160 @ 30 Hz	4096 x 2160 @ 60 Hz
Maximum resolution —dual MST	4096 x 2304 @ 60 Hz, 1400 x 1050 @ 60 Hz or 2880 x 1800 @ 60 Hz, 2880 x 1800 @ 60 Hz	Not applicable	Not applicable
Maximum resolution —triple MST	4096 x 2304 @ 60 Hz, 1360 x 768 @ 60 Hz, 640 x 480 @ 60 Hz or 2304 x 1440 @ 60 Hz, 2304 x 1440 @ 60 Hz, 2304 x 1440 @ 60 Hz	Not applicable	Not applicable
Maximum resolution —four MST	5120 x 3200 @ 60 Hz, 4096 x 2304 @ 60 Hz, 1360 x 768 @ 60 Hz, 640 x 480 @ 60 Hz or 2304 x 1440 @ 60 Hz, 2304 x 1440 @ 60 Hz, 2304 x 1440 @ 60 Hz	Not applicable	Not applicable

Hard-disk drive Preloaded bracket matrix

The following table lists the hard-disk drive preloaded bracket information of your OptiPlex 7000 Small Form Factor.

Table 45. Hard-disk drive Preloaded bracket matrix

Hard-disk drive Preloaded bracket	Available
3.5 in. Caddy/Bracket	Yes
2.5 in. Caddy/Bracket	No

Storage

3.5-inch, 4 TB, 5400 RPM, SATA, HDD

Table 46. 3.5-inch, 4 TB, 5400 RPM, SATA, HDD specifications

Capacity	4 TB	
Speed	5400 RPM	
Height (approximate)	25.40 mm (1.00 in.)	
Width (approximate)	147.06 mm (5.79 in.)	
Depth (approximate)	101.60 mm (4.00 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	7,814,037,168	
Power source		
Power consumption (reference only)	• Idle: 5 W	
	Active: 10 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	65G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

3.5-inch, 1 TB, 7200 RPM, SATA, HDD

Table 47. 3.5-inch, 1 TB, 7200 RPM, SATA, HDD specifications

Capacity	1 TB
Speed	7200 RPM
Height (approximate)	25.40 mm (1.00 in.)

Table 47. 3.5-inch, 1 TB, 7200 RPM, SATA, HDD specifications (continued)

Width (approximate)	147.06 mm (5.79 in.)	
Depth (approximate)	101.60 mm (4.00 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	1,953,525,168	
Power source		
Power consumption (reference only)	Idle: 5 W	
	Active: 10 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	65G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

3.5-inch, 2 TB, 7200 RPM, SATA, HDD

Table 48. 3.5-inch, 2 TB, 7200 RPM, SATA, HDD specifications

Capacity	2 TB	
Speed	7200 RPM	
Height (approximate)	25.40 mm (1.00 in.)	
Width (approximate)	147.06 mm (5.79 in.)	
Depth (approximate)	101.60 mm (4.00 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	3,907,029,168	
Power source		
Power consumption (reference only)	Idle: 5 WActive: 10 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	65G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

2.5-inch, 1 TB, 5400 RPM, SATA, HDD

Table 49. 2.5-inch, 1 TB, 5400 RPM, SATA, HDD specifications

Capacity	1 TB	
Speed	5400 RPM	
Height (approximate)	7.11 mm (0.28 in.)	
Width (approximate)	69.85 mm (2.75 in.)	
Depth (approximate)	100.58 mm (3.96 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	1,953,525,168	
Power source		
Power consumption (reference only)	Idle: 0.7 WActive: 3.10 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	350G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

2.5-inch, 2 TB, 5400 RPM, SATA, HDD

Table 50. 2.5-inch, 2 TB, 5400 RPM, SATA, HDD specifications

Capacity	2 TB	
Speed	5400 RPM	
Height (approximate)	7.11 mm (0.28 in.)	
Width (approximate)	69.85 mm (2.75 in.)	
Depth (approximate)	100.58 mm (3.96 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	3,907,029,168	
Power source		
Power consumption (reference only)	• Idle: 0.7 W	
	• Active: 3.10 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	

Table 50. 2.5-inch, 2 TB, 5400 RPM, SATA, HDD specifications (continued)

Relative humidity range	5% to 90%	
Op shock	350G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

2.5-inch, 500 GB, 7200 RPM, SATA, HDD

Table 51. 2.5-inch, 500 GB, 7200 RPM, SATA, HDD specifications

Capacity	500 GB	
Speed	7200 RPM	
Height (approximate)	7.11 mm (0.28 in.)	
Width (approximate)	69.85 mm (2.75 in.)	
Depth (approximate)	100.58 mm (3.96 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	976,773,168	
Power source		
Power consumption (reference only)	Idle: 0.7 WActive: 3.25 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	350G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

2.5-inch, 1 TB, 7200 RPM, SATA, HDD

Table 52. 2.5-inch, 1 TB, 7200 RPM, SATA, HDD specifications

Capacity	1 TB
Speed	7200 RPM
Height (approximate)	7.11 mm (0.28 in.)
Width (approximate)	69.85 mm (2.75 in.)
Depth (approximate)	100.58 mm (3.96 in.)
Interface	SATA 3.0
Speed (maximum)	Up to 6 Gbps

Table 52. 2.5-inch, 1 TB, 7200 RPM, SATA, HDD specifications (continued)

MTBF	550,000 hours	
Logical blocks	1,953,525,168	
Power source		
Power consumption (reference only)	Idle: 0.7 W Active: 3.25 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	350G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

2.5-inch, 500 GB, 7200 RPM, SATA, HDD, Self-Encrypting, Opal 2.0, FIPS

Table 53. 2.5-inch, 500 GB, 7200 RPM, SATA, HDD, Self-Encrypting, Opal 2.0, FIPS specifications

Capacity	500 GB	
Speed	7200 RPM OPAL SED FIPS	
Height (approximate)	7.11 mm (0.28 in.)	
Width (approximate)	69.85 mm (2.75 in.)	
Depth (approximate)	100.58 mm (3.96 in.)	
Interface	SATA 3.0	
Speed (maximum)	Up to 6 Gbps	
MTBF	550,000 hours	
Logical blocks	976,773,168	
Power source		
Power consumption (reference only)	• Idle: 0.7 W	
	Active: 3.25 W	
Environmental operating conditions (non-condensing)		
Temperature range	5°C to 60°C	
Relative humidity range	5% to 90%	
Op shock	350G @2ms	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 65°C	
Relative humidity range	5% to 95%	

M.2 2230, 256 GB, PCIe NVMe Gen3 x4, Class 35 SSD

The following table lists the M.2 2230, 256 GB SSD specifications.

Table 54. 256 GB SSD specifications

Capacity	256 GB	
Height (approximate)	2.38 mm (0.09 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	30.00 mm (1.18 in.)	
Interface type	PCIe Gen3	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	500,118,192	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4)Active: 3.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2230, 512 GB, PCIe NVMe Gen3 x4, Class 35 SSD

The following table lists the M.2 2230, 512 GB SSD specifications.

Table 55. 512 GB SSD specifications

Capacity	512 GB	
Height (approximate)	2.38 mm (0.09 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	30.00 mm (1.18 in.)	
Interface type	PCIe Gen3	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	1,000,215,216	
Power source		
Power consumption (reference only)	• Idle: 5 mW (PS4)	
	Active: 3.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	

Table 55. 512 GB SSD specifications (continued)

Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2230, 1 TB, PCIe NVMe Gen3 x4, Class 35 SSD

The following table lists the M.2 2230, 1 TB SSD specifications.

Table 56. 1 TB SSD specifications

Capacity	1 TB	
Height (approximate)	2.38 mm (0.09 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	30.00 mm (1.18 in.)	
Interface type	PCle Gen3	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	2,000,409,264	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4)Active: 3.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2230, 256 GB, PCIe NVMe Gen3 x4, Opal Self-Encrypting Class 35 SSD

The following table lists the M.2 2230, 256 GB SSD, self-encrypting drive specifications.

Table 57. 256 GB SSD, self-encrypting drive specifications

Capacity	256 GB
Height (approximate)	2.38 mm (0.09 in.)
Width (approximate)	22.00 mm (0.87 in.)
Depth (approximate)	30.00 mm (1.18 in.)
Interface type	PCIe Gen3

Table 57. 256 GB SSD, self-encrypting drive specifications (continued)

Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	500,118,192	
Power source		
Power consumption (reference only)	• Idle: 5 mW (PS4)	
	Active: 3.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2280, 512 GB, PCIe NVMe Gen4 x4, Class 40 SSD

The following table lists the M.2 2280, 512 GB SSD specifications.

Table 58. 512 GB SSD specifications

Capacity	512 GB	
Height (approximate)	2.38 mm (0.09 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	80.00 mm (3.15 in.)	
Interface type	PCle Gen4	
Speed (maximum)	64 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	1,000,215,216	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4 - L1.2)Active: 5 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	
	·	

M.2 2280, 1 TB, PCIe NVMe Gen4 x4, Class 40 SSD

The following table lists the M.2 2280, 1 TB SSD specifications.

Table 59. 1 TB SSD specifications

Capacity	1 TB	
Capacity		
Height (approximate)	2.38 mm (0.09 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	80.00 mm (3.15 in.)	
Interface type	PCIe Gen4	
Speed (maximum)	64 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	2,000,409,264	
Power source		
Power consumption (reference only)	• Idle: 5 mW (PS4 - L1.2)	
	Active: 5 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	
	•	

M.2 2280, 2 TB, PCIe NVMe Gen4 x4, Class 40 SSD

The following table lists the M.2 2280, 2 TB SSD specifications.

Table 60. 2 TB SSD specifications

Capacity	2 TB	
Height (approximate)	2.38 mm (0.09 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	80.00 mm (3.15 in.)	
Interface type	PCIe Gen4	
Speed (maximum)	64 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	4,000,797,360	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4 - L1.2)Active: 5 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	

Table 60. 2 TB SSD specifications (continued)

Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2280, 512 GB, PCIe NVMe Gen3 x4, Class 40 SSD, self-encrypting drive

The following table lists the M.2 2280, 512 GB SSD, self-encrypting drive specifications

Table 61. 512 GB SSD, self-encrypting drive specifications

rable on the about the specimental one		
Capacity	512 GB	
Height (approximate)	2.38 mm (0.09 in.)	
Width (approximate)	22.00 mm (0.87 in.)	
Depth (approximate)	80.00 mm (3.15 in.)	
Interface type	PCIe Gen3	
Speed (maximum)	32 Gb/s (up to 4 lanes)	
MTBF	1.4M hours	
Logical blocks	1,000,215,216	
Power source		
Power consumption (reference only)	Idle: 5 mW (PS4 - L1.2)Active: 4.50 W	
Environmental operating conditions (non-condensing)		
Temperature range	0°C to 70°C	
Relative humidity range	10% to 90%	
Op shock	1500G	
Environmental non-operating conditions (non-condensing)		
Temperature range	-40°C to 70°C	
Relative humidity range	5% to 95%	

M.2 2280, 1 TB, PCIe NVMe Gen3 x4, Class 40 SSD, self-encrypting drive

The following table lists the M.2 2280, 1 TB SSD, self-encrypting drive specifications

Table 62. 1 TB SSD, self-encrypting drive specifications

Capacity	1 TB
Height (approximate)	2.38 mm (0.09 in.)
Width (approximate)	22.00 mm (0.87 in.)
Depth (approximate)	80.00 mm (3.15 in.)

Table 62. 1 TB SSD, self-encrypting drive specifications (continued)

PCle Gen3			
32 Gb/s (up to 4 lanes)			
1.4M hours			
2,000,409,264			
• Idle: 5 mW (PS4 - L1.2)			
Active: 4.50 W			
0°C to 70°C			
10% to 90%			
1500G			
Environmental non-operating conditions (non-condensing)			
-40°C to 70°C			
5% to 95%			

8x DVD±RW, slimline

Table 63. 8x DVD±RW, slimline specifications

Height (without bezel)	9.50 mm (0.37 in.)		
Width (without bezel)	128.00 mm (5.04 in.)		
Depth (without bezel)	126.01 mm (4.97 in.)		
Weight (maximum)	140 grams		
Interface	SATA 1.5		
Speed (maximum)	Up to 1.5 Gbps		
Disc capacity	Standard		
Internal buffer size	0.5 MB		
Access times (typical)	Supplier dependent		
Maximum data transfer rates			
Writes	8x DVD/ 24x CD		
Reads	8x DVD/ 24x CD		
Power source			
DC power requirements	5 V		
DC current	1300 mA		
Environmental operating conditions (non-condensing)			
Operating temperature range	5°C to 60°C		
Relative humidity range	10% to 90% RH		
Maximum wet bulb temperature	29°C		
Altitude range	0 m to 3048 m		
Environmental non-operating conditions (non-condensing)			

Table 63. 8x DVD±RW, slimline specifications (continued)

Operating temperature range	-40°C to 65°C
Relative humidity range	5% to 95% RH
Maximum wet bulb temperature	38°C
Altitude range	0 m to 10600 m

Media-card reader

The following table lists the media-card reader specifications on your OptiPlex 7000 Small Form Factor.

Table 64. Media-card reader (standard offering)

Media supported (Maximum capacity supported will vary by Flash Media Types)			
Media Supported	SDXC, SDHC, SD		
	Secure Digital (SD) 4.0 UHS-II		
	Secure Digital (SD) 3.0 UHS-I		
Support Specification Versions	Secure Digital (SD) 4.0		
Power source	·		
Max Power Requirements	1.2 A		
Supply Voltage Range	3.3 V		
Power Consumption	MS 0.08 mA		
Environmental operating conditions (Non-condensing)			
Operating Temperature Range	0°C to 70°C		
Relative Humidity Range	N/A		
Environmental non-operating conditions (Non-condensing)			
Operating Temperature Range	N/A		
Relative Humidity Range	N/A		

Power ratings

The following table lists the power ratings specifications of your OptiPlex 7000 Small Form Factor.

Table 65. Power ratings specifications

Description	Values			
Туре	240 W (85% Efficient, 80 Plus Bronze)	260 W (85% Efficient, 80 Plus Bronze)	300 W (92% Efficient, 80 Plus Platinum)	
Diameter (connector)	Not supported	Not supported	Not supported	
Input voltage	90 VAC to 264 VAC	90 VAC to 264 VAC	90 VAC to 264 VAC	
Input frequency	47 Hz to 63 Hz	47 Hz to 63 Hz	47 Hz to 63 Hz	
Input current (maximum)	4 A	4.2 A	4.2 A	

Table 65. Power ratings specifications (continued)

Description	Values		
Output current (continuous)	 12 VA/18 A 12 VB/15 A Standby mode: 12 VA/1.5 A 12 VB/3.3 A 	 12 VA/18 A 12 VB/16 A Standby mode: 12 VA/1.5 A 12 VB/3.3 A 	 12 VA/18 A 12 VB/18 A Standby mode: 12 VA/1.5 A 12 VB/3.3 A
Rated output voltage	• +12 VA • +12 VB	+12 VA+12 VB	• +12 VA • +12 VB
BTUs/h (based on PSU max wattage)	818	888	1023
Temperature rang	e		
Operating	5°C to 45°C (41°F to 113°F)	5°C to 45°C (41°F to 113°F)	5°C to 45°C (41°F to 113°F)
Storage	-40°C to 70°C (-40°F to 158°F)	-40°C to 70°C (-40°F to 158°F)	-40°C to 70°C (-40°F to 158°F)
Compliance			
Erp Lot6 Tier 2 requirement	Yes	Yes	Yes
80Plus compliant	Yes	Yes	Yes
Energy Star 8.0 compliant	Yes	Yes	Yes
GS mark compliant	Yes	Yes	Yes
FEMP Standby Power Compliant	Yes	Yes	Yes

Thermal dissipation

The following table lists the thermal dissipation of your OptiPlex 7000 Small Form Factor.

Table 66. Thermal dissipation

Power supply unit	Heat dissipation	Voltage
240 W (80 Plus Bronze)	240*3.412=818 BTU/hr	100 to 240 VAC, 50 to 60 Hz, 4.2 A/2.1 A
260 W (80 Plus Bronze)	260*3.412=888 BTU/hr	100 to 240 VAC, 50 to 60 Hz, 4.2 A/2.1 A
300 W (80 Plus Platinum)	300*3.412=1023 BTU/hr	100 to 240 VAC, 50 to 60 Hz, 4.2 A/2.1 A

CMOS battery

The following table lists the CMOS battery specifications of your OptiPlex 7000 Small Form Factor.

Table 67. CMOS battery

Brand	Туре	Voltage	Composition	Battery life
MITSUBISHI	CR2032	3.0 V		Continuous Discharge Under 15 kΩ Load to 2.0 V End-Voltage. 20°C±2°C 940 Hrs. or Longer.910 Hrs.or Longer after 12 mo.

Accessories

The following table lists the supported accessories on your OptiPlex 7000 Small Form Factor.

Table 68. Accessories

Accessories
Dell Pro Wireless Keyboard and Mouse - KM5221W
Dell Slim Soundbar - SB521A
Dell Pro Stereo Headset - WH3022
Dell commercial displays including E series, Professional P series, UltraSharp, and Collaboration monitors

Security

Software security

The following table lists the software security details of your OptiPlex 7000 Small Form Factor.

Table 69. Software security

Security options
McAfee® Small Business Security 30-day Free Trial
McAfee® Small Business Security 12-month subscription
McAfee® Small Business Security 36-month Subscription
Intel Guard Technologies & Secure Key: Software Guard (SGX), Data Guard (vPro only), Boot Guard, BIOS Guard (Core CPU's only), OS Guard (Core CPU's only) and Secure Key (i5 or greater only)
Intel Runtime BIOS Resilience (Copper Point) with attestation via Nifty Rock + Intel TXT
Support of Absolute Persistent Module BIOS agent v2
OpenXT validation required
SafeGuard and Response, powered by VMware Carbon Black and Secureworks
Next Generation Antivirus (NGAV)
Endpoint Detection and Response (EDR)
Threat Detection and Response (TDR)

Table 69. Software security (continued)

Security options
Managed Endpoint Detection and Response
Incident Management Retainer
Emergency Incident Response

Dell ControlVault 3.0

The following table lists the Dell ControlVault 3.0 specifications of your OptiPlex 7000 Small Form Factor.

Table 70. Dell ControlVault 3.0 specifications

Title	Description	Dell ControlVault 3.0
CPU technology	N/A	1 GHz ARM Cortex A7
RAM	N/A	1 MB
ROM	N/A	16 MB
TPM included	TPM enumeration included within ControlVault	No
Host Interface	N/A	USB 2.0
Fingerprint procession on chip	Fingerprint processing occurs within secure boundary of ControlVault	Yes
Windows WBF support	Support for Windows biometric framework when Fingerprint reader is attached	Yes
FIPS 140-2 level 3 complaint	Device complaint with FIPS 140-2 level 3 requirements	Yes
FIPS 140-2 level 3 certified	Device certified with FIPS 140-2 level 3 requirements	Yes

Trusted Platform Module

The following table lists the Trusted Platform Module (TPM) of your OptiPlex 7000 Small Form Factor.

Table 71. Trusted Platform Module (TPM)

TPM: ST/ST33 HTPH2X32AHD8
SPI interface
TPM 2.0
FIPs 140-2 certificate

Mil-SPEC

The OptiPlex 7000 Small Form Factor meets military specifications for the following MIL-STD 810H tests:

Table 72. Small Form Factor - Military specifications

Test Category	Test Method	Test Parameters		
Altitude Storage Transport		Test Pressure: Equivalent to cabin altitude of 19 Temperature: 21°C; Altitude Change Rate: <10		

Table 72. Small Form Factor - Military specifications (continued)

Test Category	Test Method	Test Parameters		
		Duration: 1 hour		
Altitude Operation/Air Carriage	Method 500.6 Procedure II	Test Pressure: Equivalent to cabin altitude of 15 Temperature: 21°C; Altitude Change Rate: <10 r Duration: 1 hour		
High Temperature Storage and Transition	Method 501.7 Procedure I	Duration: 7-day exposure (7 X 24-hr. cycles) Temperature: 33 °C-71 °C (nonoperational / st Table 501. 7 - III High temperature cycles. Climate category A1 Hot Dry		
High Temperature Operational	igh Temperature Operational Method 501.7 Procedure II Duration: 5-day Temperature: 3 High Temperat Climate categor			
Low Temperature (Exaggerated)	Method 502.7 Procedure I - Storage	Duration: 24-hour exposure Temperature: -51°C		
Low temperature	Method 502.7 Procedure II - Operation	Duration: 24-hour exposure Temperature: -29°C		
Humidity Induced (Storage andTransit) and Natural and Cycles	Method 507.6 Procedure I	Duration: Table 507.6-II, (Hot-humid Cycle B3) Material Category: Non-Hazardous Items Norma Duration.		
Sand and Dust Blowing Dust	Method 510. 7 Procedure I	Duration: 12 hours Air velocity = 1.5 m/s (300 ft/min) to 8.9 m/s (min) Temperature:60°C Relative Humidity: 30%		
Vibration	Method 514. 8 Procedure I - Category4	Operational Vibration, 10-500 Hz, 1.04 Grms, ra hour on Bottom, Left, and Back side. Unit is ope during test.		
Vibration - Minimum integrity test	Method 514.8 Procedure I - Category 24	Non-OP vibration, 20-2000 Hz, 7.69 Grms Test Duration: 1 hr Test axis: X,Y, and Z.		
Shock - Transportation Shock	Method 516. 8 Procedure II: Material to be Packaged	On-road Shock, 5.1 g / 11 m (Table 516-8-VII) Off-road Shocks 15.2 g / 5 ms (Table 516-8-VII) Test unit orientations at x, y and z axis for both to the second se		

Table 72. Small Form Factor - Military specifications (continued)

Test Category	Test Method	Test Parameters
Shock - Crash Hazard Shock	Method 516.8 Procedure V	Non-Operational. 185 g, 2 ms Half Sine 2 shocks direction for a total of 12 shocks
		NOTE: Dell to use noted test to replace MIL STD-8108, Method 516.8, Procedure V, Tab XIII.
Bench Handling	Method 516. 8 Procedure VI	Angle drops onto solid wooden bench thickness cm (1.675 inch). Test height judgment as two cas rise test units at one edge 100 mm (4 in.) or angle of 45° about a solid wooden bench top.

Acoustic noise emission information tower

The following table lists the acoustic noise emission information of your OptiPlex 7000 Small Form Factor.

Table 73. Acoustic noise emission information tower

Component	Test Configuration
CPU	Intel Pentium G6405
Memory	4 GB
HDD (#, capacity)	2.5-inch hard drive
ODD	No
Graphics Adapter	Intel UHD Graphics 610

Table 74. Declared Sound Power (LWAd)

Operating Mode	Declared Sound Power(LWAd)
Idle	3.5
HDD Operating	3.6
CPU Stressed	3.8
ODD Operating	4.0

Table 75. A-Weighted Sound Pressure Level (dB)

Declared Sound Pressure (LpA)					
	Tabletop System		Floor Standing System		
Operating Mode	Operator Position	Bystander Position	Operator Position	Bystander Position	
Idle	25.3	N/A	N/A	N/A	
CPU Stressed	26.6	N/A	N/A	N/A	

All tests are conducted according to ISO 7779 and declared according to ISO 9296 except CPU Stressed. This test mode is not specified in ISO 7779, but was measured using the same microphone distances and measurement techniques defined for the other reported operating modes.

Declared Sound Power rounded to nearest tenth of a bel per ISO 9296 section 4.4.2

Chassis enclosure and ventilation requirements

Enclosure ventilation

If your enclosure has doors, they need to be of a type that allows at least 30% airflow through the enclosure (front and back).

Enclosure minimum clearance

Leave a 10.2 cm (4 in.) minimum clearance on all vented sides of the computer to permit the airflow required for proper ventilation.

Recommended enclosure

Do not install your computer in an enclosure that does not allow airflow/dusty environment/temperate over 35°C. Do not put any objects to directly block air-vent. This restricts the airflow and impacts your computer's performance, possibly causing it to overheat.

Open desk minimum clearance

If your computer is installed in a corner, on a desk, or under a desk, leave at least 5.1 cm (2 in.) clearance from the back of the computer to the wall to permit the airflow required for proper ventilation.

System management features

Dell commercial systems come with a number of systems management options that are include by default for In-Band management with our Dell Client Command Suite. In-Band management meaning that the Operating System is functional and the device is connected to a network so that it can be managed. The Dell Client Command Suite of tools can be leveraged individually or with a systems management console like SCCM, LANDESK, KACE, etc.

We also offer Out-of-Band management as an option. Out-of-band management is when the system does not have a functional operating system or is turned off and you still want to be able to manage the system in that state.

Dell Client Command Suite for In-Band systems management

Dell Client Command Suite is a free toolkit available for download, for all Latitude Rugged tablets at dell.com/support, that automates and streamlines systems management tasks, saving time, money, and resources. It consists of the following modules that can be used independently, or with a variety of systems management consoles such as SCCM.

Dell Client Command Suite's integration with VMware Workspace ONE Powered by AirWatch, now allows customers to manage their Dell client hardware from the cloud, using a single Workspace ONE console.

Dell Command | Deploy enables easy operating system (OS) deployment across all major OS deployment methodologies and provides numerous system-specific drivers that have been extracted and reduced to an OS-consumable state.

Dell Command I Configure is a graphical user interface (GUI) admin tool for configuring and deploying hardware settings in a pre-OS or post-OS environment, and it operates seamlessly with SCCM and Airwatch and can be self-integrated into LANDesk and KACE. Simply, this is all about the BIOS. Command I Configure allows you to remotely automate and configure over 150+BIOS settings for a personalized user experience.

Dell Command I PowerShell Provider can do the same things as Command I Configure, but with a different method. PowerShell is a scripting language that allows customers to create a customized and dynamic configuration process.

Dell Command I Monitor is a Windows Management Instrumentation (WMI) agent that provides IT admins with an extensive inventory of the hardware and health-state data. Admins can also configure hardware remotely by using command line and scripting.

Dell Command I Power Manager (end-user tool) is a GUI-based factory-installed battery management tool that allows end users to choose the battery management methods that meet their personal preferences or work schedule without sacrificing IT's capability to control those settings with Group Policy.

Dell Command | Update (end-user tool) is factory-installed and allows admins to individually manage and automatically present and install Dell updates to the BIOS, drivers, and software. Command I Update eliminates the time-consuming hunting and pecking process of update installation.

Dell Command I Update Catalog provides searchable metadata that allows the management console to retrieve the latest system-specific updates (driver, firmware or BIOS). The updates are then delivered seamlessly to end-users using the customer's systems management infrastructure that is consuming the catalog (like SCCM).

Dell Command | vPro Out of Band console extends hardware management to systems that are offline or have an unreachable OS (Dell exclusive features).

Dell Command | Integration Suite for System Center - This suite integrates all the key components of the Client Command Suite into Microsoft System Center Configuration Manager 2012 and Current Branch versions.

Out of Band Systems Management

Intel Standard Manageability option **must be configured in our factory at the time of purchase, as it is NOT field upgradable.** It offers out-of-band management and DASH compliance (https://registry.dmtf.org/registry/results/field_initiative_name%3A%22DASH%201.0%22).

Intel vPro Enterprise

Intel vPro provides an enhanced level of built-in security, hardware-level security and comprehensive cyber defense. Intel vPro allows you to remotely power on devices, streamline PC life cycle management without compromising productivity, secure, repair and maintain when needed.

Systems configured with Intel Core i5/i7/i9 processors support Intel vPro Enterprise. Check the processor specifications section for the list of Intel vPro enabled processors.

Critical callouts

This section contains information about some new features and need-to-know information about this computer.

- System not supporting modern standby Add-in cards
- 2.5-inch/3.5-inch Hard drive spindle expected behavior on MODS platforms

System not supporting modern standby - Add-in cards

Affected platforms: OptiPlex 7000 Small Form Factor

- Legacy PCI cards does not support MODS through TI PCI bridge.
- Zoom2 card that is offered as CUS kit.
- ESG hard drive offered as CUS kit.

Computers configured with the listed add-in cards, shipped as CUS kits, will not support Modern Standby natively.

2.5-inch/3.5-inch Hard drive spindle expected behavior on MODS platforms

Affected platforms: OptiPlex 7000 Small Form Factor

System fails to enter Modern Standby (MoDS) intermittently on systems configured with SATA hard drives. The computer may fail to meet the required (>90%) power reduction to enter a deepest runtime idle platform state (DRIPS). The power, PSU, and Hard-drive LED will be off in this state and the chassis fan will not spin.

This is a known limitation in Windows on computers that are configured with a spindle type hard drive (HDD).

Table 76. Expected system behavior

System behavior	Screen	dGfx fan	Hard drive LED	PWR LED	PSU LED	PSU fan	CPU fan	System fan
MODS "Should be"	Off	Off	Off	Off	Off	Off	Off	Off
MODS first entry on SATA hard drive	Off	Off/On (Up to dGfx)	On	Off	On	On	On	On
MODS normal after second entry on SATA hard drive	Off	Off	Off	Off	Off	Off	Off	Off

Getting help and contacting Dell

Self-help resources

You can get information and help on Dell products and services using these self-help resources:

Table 77. Self-help resources

Self-help resources	Resource location			
Information about Dell products and services	www.dell.com			
My Dell app	Dear			
Tips				
Contact Support	In Windows search, type Contact Support, and press Enter.			
Online help for operating system	www.dell.com/support/windows			
	www.dell.com/support/linux			
Access top solutions, diagnostics, drivers and downloads, and learn more about your computer through videos, manuals and documents.	Your Dell computer is uniquely identified by a Service Tag or Express Service Code. To view relevant support resources for your Dell computer, enter the Service Tag or Express Service Code at www.dell.com/support. For more information on how to find the Service Tag for your computer, see Locate the Service Tag on your computer.			
Dell knowledge base articles for a variety of computer concerns	 Go to www.dell.com/support. On the menu bar at the top of the Support page, select Support > Knowledge Base. In the Search field on the Knowledge Base page, type the keyword, topic, or model number, and then click or tap the search icon to view the related articles. 			

Contacting Dell

To contact Dell for sales, technical support, or customer service issues, see www.dell.com/contactdell.

- (i) NOTE: Availability varies by country/region and product, and some services may not be available in your country/region.
- NOTE: If you do not have an active Internet connection, you can find contact information about your purchase invoice, packing slip, bill, or Dell product catalog.